

## 1. General description

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The SSL21084T is a high-voltage Integrated Circuit (IC) for driving retrofit LED lamps in general lighting applications. It enables the implementation of a very compact low-cost system solution. The IC incorporates an integrated internal HV switch and works as Boundary Conduction Mode (BCM) buck converter.

The SSL21084T is supplied by a start-up bleeder resistor, a  $dV/dt$  supply using capacitive coupling from the drain or any other auxiliary supply. The IC supply current is low. An internal clamp limits the supply voltage.

The IC has accurate output current control and can be operated using Pulse-Width Modulation (PWM) dimming. In addition, several protection features are available such as easy external temperature feedback.

The main benefits of this IC include:

- Small Printed-Circuit Board (PCB) footprint and compact solution
- High efficiency (up to 90 %) for non-dimmable high power factor solutions
- High power factor ( $>0.9$ )
- Ease of integration and many protection features
- Low electronic Bill Of Material (BOM)
- Mains phase-cut dimmable using external components
- Highly flexible IC for use in buck, buck/boost modes
- Single inductor used for non-isolated configurations because of internal demagnetization detection and  $dV/dt$  supply

The IC range is designed to start up directly from the HV supply using an internal high-voltage current source. An internal clamp limits the supply voltage.

## 2. Features and benefits

- LED driver IC for driving strings of LEDs or high-voltage LED modules from a rectified mains supply
- Power-efficient boundary conduction mode operation with:
  - ◆ No reverse recovery losses in freewheel diode
  - ◆ Zero-Current Switching (ZCS) for switch turn-on
  - ◆ Zero-voltage or valley switching for switch turn-off
  - ◆ Minimal required inductance value and size
- Fast transient response through cycle-by-cycle current control:
  - ◆ No overshoot or undershoot in the LED current
- Simple high input power factor solution ( $>0.9$ )
- Internal Protection features:
  - ◆ UnderVoltage LockOut (UVLO)
  - ◆ Leading-Edge Blanking (LEB)
  - ◆ OverCurrent Protection (OCP)
  - ◆ Short-winding protection (SWP)
  - ◆ Internal OverTemperature Protection (OTP)
  - ◆ Brownout protection
  - ◆ Output Short Protection (OSP)
- Mains phase cut dimmable LED driver solution:
  - ◆ Supports both leading-edge and trailing-edge dimmers
  - ◆ Easy external temperature protection with a single NTC
  - ◆ Open output protection using external components
  - ◆ Compatible with wall switches with built-in indication light during standby
- IC lifetime easily matches or surpasses LED lamp lifetime
- Input current distributed evenly over the phase, reducing required output capacitor size and bleeder dissipation

## 3. Applications

The SSL21084T are intended for mains dimmable compact LED lamps for single mains input voltages. Mains input voltages include 100 V (AC), 120 V (AC) and 230 V (AC).

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V <sub>CC</sub>	supply voltage	operating range	[1] 8	-	16	V
R <sub>DSon</sub>	drain-source on-state resistance	T <sub>J</sub> = 25 °C	4	5	6	Ω
		T <sub>J</sub> = 125 °C	6	7.5	9	Ω
I <sub>DRAIN</sub>	current on pin DRAIN		-1	-	+1	A
V <sub>DRAIN</sub>	voltage on pin DRAIN		-0.4	-	+600	V
f <sub>conv</sub>	conversion frequency		-	100	-	kHz

[1] An internal clamp sets the supply voltage. The current into the VCC pin must not exceed the maximum I<sub>DD</sub> value (see Table 4).

## 5. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
SSL21084T	SO12	plastic small package outline body; 12 leads; body width 3.9 mm	SOT1196-1

6. Block diagram

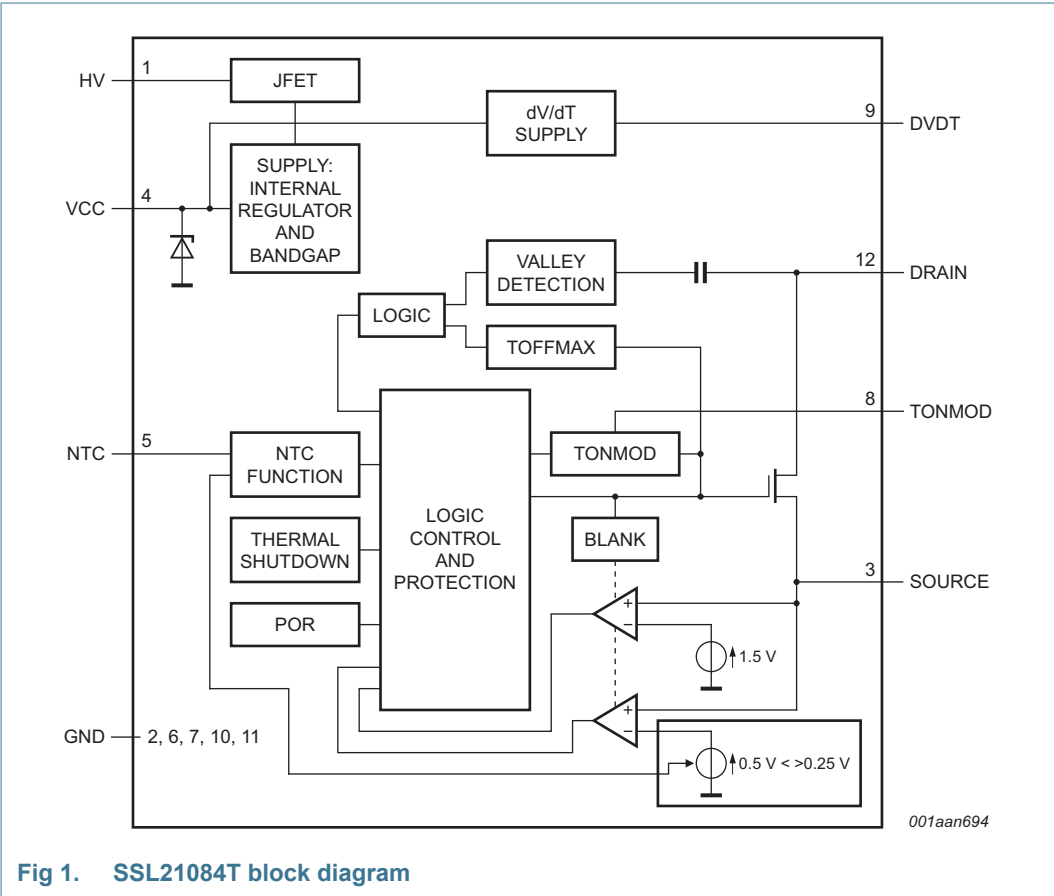
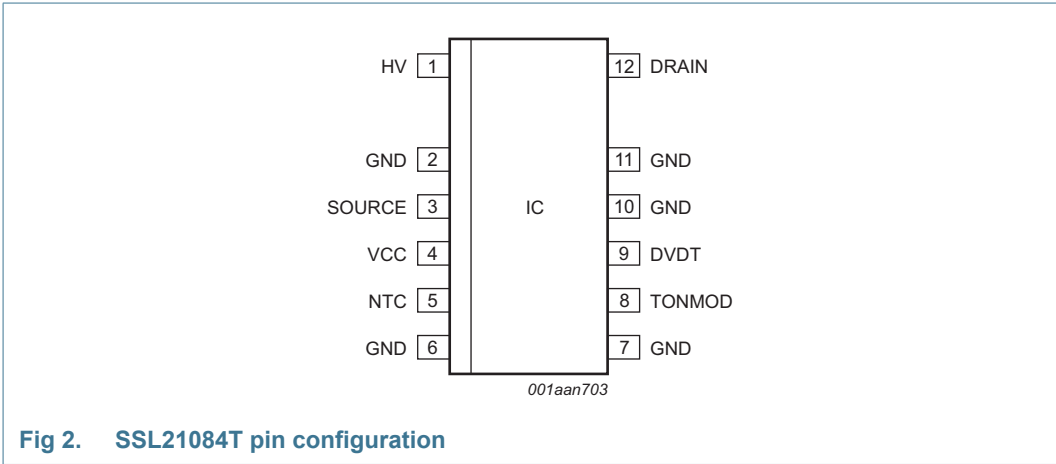


Fig 1. SSL21084T block diagram

7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
HV	1	high-voltage supply pin
GND	2, 6,7, 10, 11	ground
SOURCE	3	low-side external switch
VCC	4	supply voltage
NTC	5	temperature protection input
TONMOD	8	on-time modulation input
DVDT	9	AC supply pin
DRAIN	12	high-side external switch

## 8. Functional description

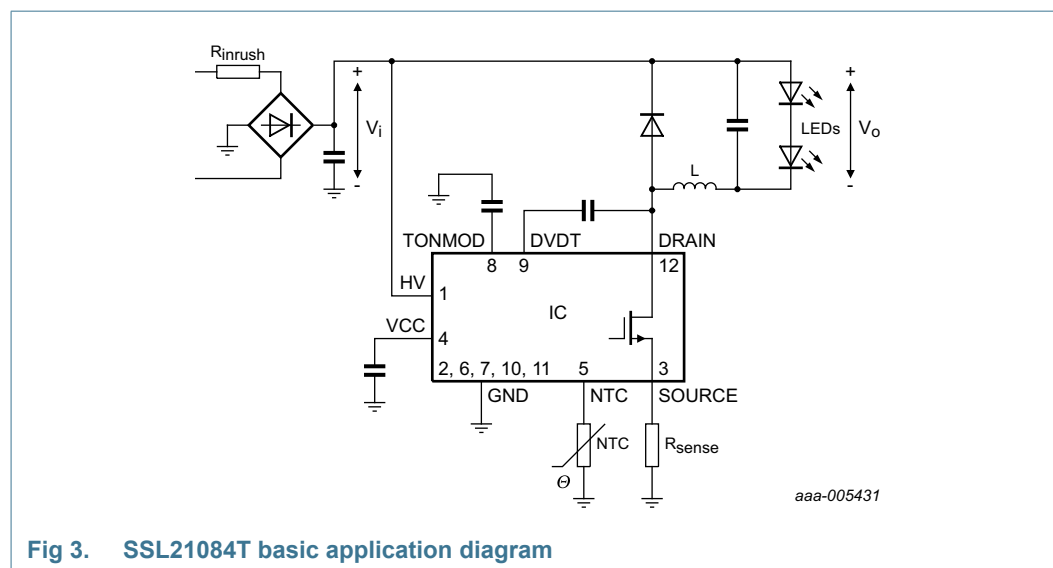
## 8.1 Introduction

The SSL21084T is a driver IC solution for small form factor mains phase-cut dimmable LED lamps in isolated and non-isolated applications.

## 8.2 Converter operation

The converter in the SSL21084T is a Boundary Conduction Mode (BCM), peak current controlled system. See [Figure 3](#) for the basic application diagram. See [Figure 4](#) for relevant the waveforms.

This converter type operates at the boundary between continuous and discontinuous mode. Energy is stored in inductor L each period that the switch is on. The inductor current  $I_L$  is zero when the MOSFET is switched on. The amplitude of the current build-up in L is proportional to the voltage drop over the inductor and the time that the MOSFET switch is on. When the MOSFET is switched off, the energy in the inductor is released towards the output. The current then falls at a rate proportional to the value of  $V_O$ . The LED current  $I_{LED}$  depends on the peak current through the inductor (SSL21084T controlled) and on the dimmer angle while it is optimized for a high-power factor. A new cycle is started once the inductor current  $I_L$  is zero. This quasi-resonant operation results in higher efficiency.



### 8.3 Valley detection

A new cycle is started when the primary switch is switched on (see Figure 4). In the following sections, “on” represents the conductive state and off the non-conductive state.

Following time  $t_1$ , when the peak current is detected on the SOURCE pin, the switch is turned off and the secondary stroke starts at  $t_2$ . When the secondary stroke is completed with the coil current at  $t_3$  equaling zero, the drain voltage starts to oscillate at approximately the  $V_i - V_O$  level. The peak to peak amplitude equals  $2 \times V_O$ . In a tapped buck topology, this amplitude is multiplied by the ratio of the windings.

A special feature, called valley detection is an integrated part of the SSL21084T circuitry. Dedicated built-in circuitry connected to the DRAIN pin, senses when the voltage on the drain of the switch reaches its lowest value. The next cycle is then started at  $t_{00}$  and as a result the capacitive switching losses are reduced. If both the frequency of the oscillations and the voltage swing are within the range specified ( $f_{ring}$  and  $\Delta V_{vrec(min)}$ ) for detection, a valley is detected and accepted. If a valid valley is not detected, the secondary stroke is continued until the maximum off-time ( $t_{off(high)}$ ) is reached. Then the next cycle is started.

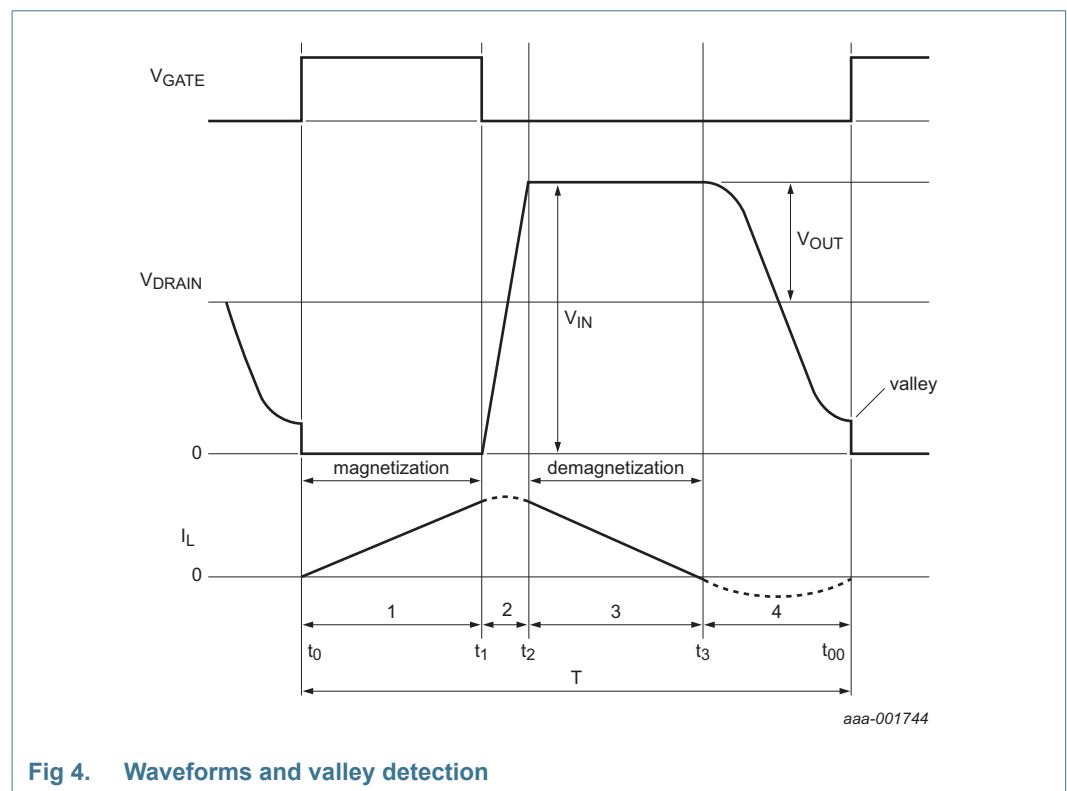


Fig 4. Waveforms and valley detection

## 8.4 Protective features

The IC has the following protective features:

- UnderVoltage LockOut (UVLO)
- Leading-Edge Blanking (LEB)
- OverCurrent Protection (OCP)
- Internal OverTemperature Protection (OTP)
- Brownout protection
- Short-winding protection (SWP)
- LED overtemperature control and protection
- An optional output OverVoltage Protection circuit is implemented using external components and the NTC pin.
- Output Short Protection (OSP)

The internal OTP and LED overtemperature protections are safe-restart protections. The IC halts, causing  $V_{CC}$  to drop to below  $V_{CC(stop)}$  and triggers a start-up. When  $V_{CC}$  drops to below  $V_{CC(rst)}$ , the IC resets the latch protection mode. If  $V_{CC}$  drops to below  $V_{CC(stop)}$ , the IC halts. Switching starts only when no fault condition exists.

### 8.4.1 UnderVoltage LockOut (UVLO)

When the voltage on the VCC pin  $< V_{CC(stop)}$ , the IC stops switching. An attempt is then made to restart by supplying  $V_{CC}$  from the HV pin voltage.

### 8.4.2 Leading-Edge Blanking (LEB)

To prevent false detection of the short-winding or overcurrent, a blanking time following switch-on is implemented. When the MOSFET switch switches on there can be a short current spike due to capacitive discharge of voltage over the drain and source and the charging of the gate to source capacitance. During the LEB time ( $t_{leb}$ ), the spike is disregarded.

### 8.4.3 OverCurrent Protection (OCP)

The SSL21084T contains a highly accurate peak current detector. It triggers when the voltage on the SOURCE pin reaches the peak level  $V_{th(ocp)SOURCE}$ . The current through the switch is sensed using a resistor connected to the SOURCE pin. The sense circuit is activated following LEB time  $t_{leb}$ . As the LED current is half the peak current (by design), it automatically provides protection for maximum LED current during operation. There is a propagation delay ( $t_{d(ocp-swoff)}$ ) between the overcurrent detection and the actual switching off of the switch. Due to the delay, the actual peak current is slightly higher than the OCP level set by the resistor in series to the SOURCE pin.

### 8.4.4 OverTemperature Protection (OTP)

When the internal OTP function is triggered at a certain IC temperature ( $T_{th(act)otp}$ ), the converter stops operating. The OTP safe-restart protection and the IC restart with switching resuming when the IC temperature drops below  $T_{th(rel)otp}$ .



#### 8.4.5 Brownout protection

Brownout protection is designed to limit the lamp power when the input voltage drops close to the output voltage level. The input power must remain constant. The input current would otherwise increase to a level that is too large for the input circuitry. In the SSL21084T, there is a maximum limit on the on-time of switch  $t_{on(high)}$ .

In buck mode, the rate of current rise in the coil during the on-phase is proportional to the difference between input voltage and output voltage. Therefore, the peak current cannot be reached before  $t_{on(high)}$  and as a result the average output current to the LEDs is reduced.

#### 8.4.6 $t_{on}$ control

The  $t_{on(high)}$  can be lowered by connecting a capacitor to the TONMOD pin. The external capacitor is charged during the primary stroke with  $I_{offset(TONMOD)}$ . If the  $V_{th(TONMOD)}$  level is reached before the  $t_{on(high)}$  time, the switch is turned off and the secondary stroke starts. When a capacitor is not connected to the pin,  $V_{th(TONMOD)}$  is reached quickly, shorter than the minimum limit of 1  $\mu s$ . In this case or when the TONMOD pin is grounded, the internal time constant,  $t_{on(high)}$  determines the maximum on-time. This function is used to control the converter operation over the mains cycle which enables the design of a mains dimmable driver.

#### 8.4.7 Short-Winding Protection (SWP)

This protection activates when there is a steep rising current on the SOURCE pin. This current occurs when there is very small inductor or no inductor is present at all between the input voltage and DRAIN pin. When the voltage on the SOURCE pin is  $> 1.5 V$  after the leading-edge blanking time, the latched protection is triggered.

#### 8.4.8 Output Short-circuit Protection (OSP)

During the secondary stroke (switch-off time), if a valley is not detected within the off-time limit ( $t_{off(high)}$ ), then typically the output voltage is less than the minimum limit allowed in the application. This condition can occur either during start-up or due to a short-circuit. A timer  $t_{det(sc)}$  is started when  $t_{off(high)}$  is detected. Timer  $t_{det(sc)}$  is reset when a valid valley detection occurs in one of the subsequent cycles or when  $V_{CC}$  drops to below  $V_{CC(stop)}$ .

The timer can also be reset if the maximum limit on the on-time of the switch ( $t_{on(high)}$ ) is reached, which is usually the case at start-up (brownout protection). If no valley is detected and ( $t_{on(high)}$ ) is not reached before  $t_{det(sc)}$ , then it is concluded that a real short-circuit exists. The IC enters latched protection. If  $V_{CC}$  drops to below  $V_{CC(rst)}$ , the IC resets the latched protection mode (see [Figure 5](#)). During PWM dimming, the OSP timer is paused during the off cycle.

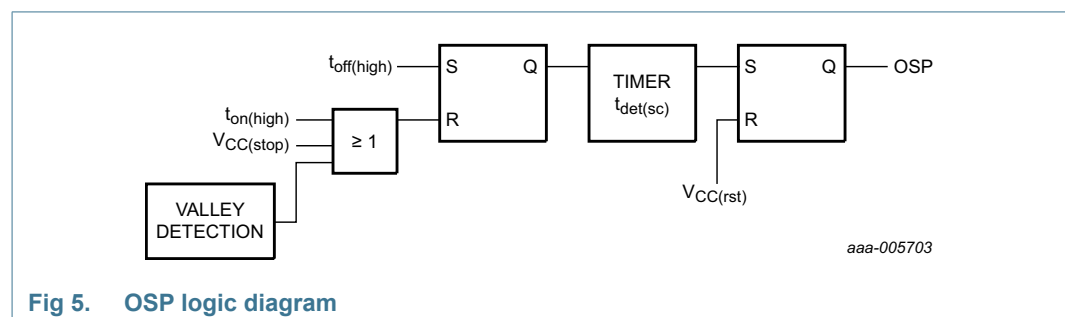


Fig 5. OSP logic diagram

The value of  $t_{on(high)}$  depends on the capacitor connected to the TONMOD pin. An open or shorted TONMOD pin sets  $t_{on(high)}$  to 15  $\mu s$  (see [Section 8.4.6](#) and [Table 6](#)).

## 8.5 VCC supply

The SSL21084T can be supplied using three methods:

- Under normal operation, the voltage swing on the DVDT pin is internally rectified to provide current on the VCC pin
- At start-up, there is an internal current source connected to the HV pin. The current source provides internal power until either the dV/dt supply or an external current on the VCC pin provides the supply.
- Using an auxiliary winding, the voltage can be rectified and connected to the VCC pin via a series resistor.

The IC starts up when the voltage at the VCC pin exceeds  $V_{CC(startup)}$ . The IC locks out (stops switching) when the voltage on the VCC pin is lower than  $V_{CC(stop)}$ . The hysteresis between the start and stop levels allows the IC to be supplied by a buffer capacitor until the external supply is stable. The SSL21084T has an internal  $V_{CC}$  clamp, which is an internal active Zener (or shunt regulator). This internal active Zener limits the voltage on the supply VCC pin to the maximum value of  $V_{CC}$ . If the maximum current of the supply minus the current consumption of the IC (determined by the load on the gate drivers), is lower than the maximum value of  $I_{DD}$ , an external Zener diode is not needed in the supply circuit.

### 8.5.1 VCC regulator

During supply dips, the input voltage can drop too low to supply the required IC current. Under these conditions, if the VCC voltage drops lower than  $V_{CC(swon)reg}$  level, a second regulator is started. Its function is to fill in the required supply current which the external supply does not deliver. It prevents the IC going into UVLO. When the VCC voltage exceeds  $V_{CC(swon)reg}$  level, the regulator is turned off.

## 8.6 DVDT pin supply (dV/dt)

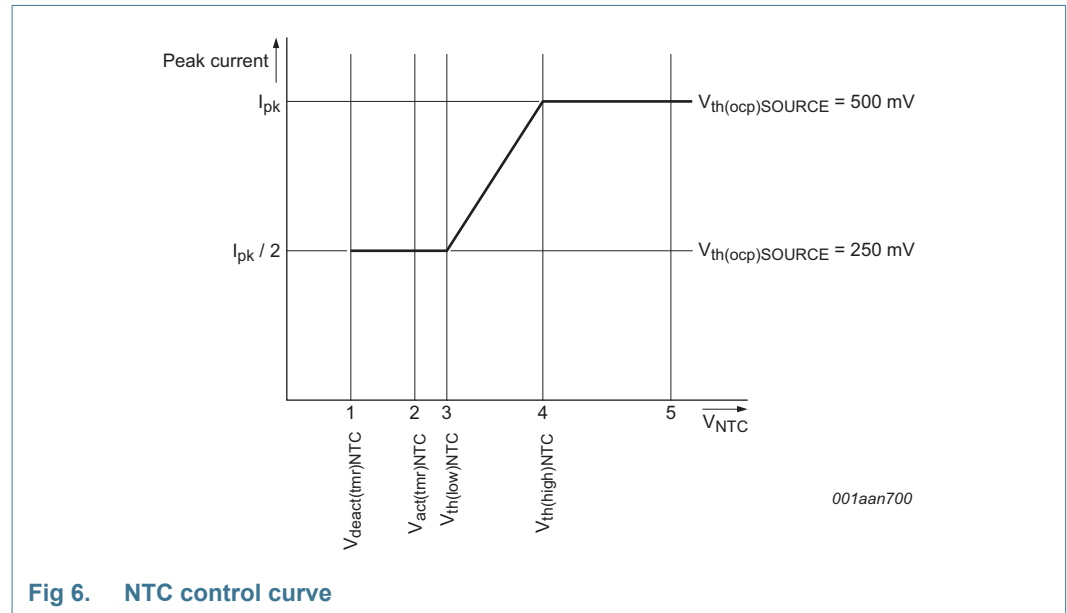
The DVDT pin is connected to an internal single-sided rectification stage. When an alternating voltage with sufficient amplitude is supplied to this pin, the IC can be powered without another external power connection. This provides a compact and effective solution without introducing high power losses and without requiring an additional inductor winding.

## 8.7 NTC functionality and PWM dimming

The NTC pin can be used as a control method for LED thermal protection. Alternatively, the pin can be used as an input to disable/enable light output using a digital signal (PWM dimming). The pin has an internal current source that generates the current of  $I_{offset(NTC)}$ . An NTC resistor to monitor the LED temperature can be directly connected to the NTC pin. Depending on the resistance value and the corresponding voltage on the NTC pin, the converter reacts as shown in [Figure 6](#).

During start-up, before  $V_{CC}$  reaches  $V_{CC(startup)}$  the voltage on the NTC pin must be less than the minimum value of  $V_{act(tmr)NTC}$ . This is valid when the voltage on the NTC pin is derived from the  $V_{CC}$  using a resistive divider and a PTC in series with the resistor between pins VCC and NTC.

If an NTC resistor is connected between the NTC pin and ground, the voltage on the NTC pin is 0 V when  $V_{CC}$  reaches  $V_{CC(startup)}$ .



**Fig 6. NTC control curve**

When the voltage on the NTC pin exceeds  $V_{th(high)NTC}$  (see Figure 6 (4)), the converter delivers nominal output current. When the voltage is lower than this level, the peak current is gradually reduced until  $V_{th(low)NTC}$  is reached (see Figure 6 (3)). The peak current is now half the peak current of nominal operation. When  $V_{act(tmr)NTC}$  is passed (see Figure 6 (2)) a timer starts to run to distinguish between the following situations:

- If the low-level  $V_{deact(tmr)NTC}$  is not reached within time  $t_{to(deact)NTC}$  (see Figure 6 (1)) LED overtemperature is detected. The IC stops switching and attempts to restart from the HV pin voltage. The converter restarts from an NTC protection shutdown when the voltage on the NTC pin exceeds  $V_{th(high)NTC}$  (see Figure 6 (4)). It is assumed that the reduction in peak current does not result in a lower NTC temperature and LED OTP is activated.
- If the low-level  $V_{deact(tmr)NTC}$  is reached within the time  $t_{to(deact)NTC}$  (see Figure 6 (1)) it is assumed that the pin is pulled down externally. The restart function is not triggered. Instead, the output current is reduced to zero. PWM dimming can be implemented this way. The output current rises again when the voltage is higher than  $V_{th(low)NTC}$ .

### 8.7.1 Soft-start function

The NTC pin can be used to make a soft start function. During switch-on, the level on the NTC pin is low. By connecting a capacitor (in parallel with the NTC resistor), a time constant can be defined. The time constant causes the level on the NTC pin to increase slowly. When passing level  $V_{th(low)NTC}$  (see Figure 6 (3)), the convertor starts with half of the maximum current. The output current slowly increases to maximum when  $V_{th(high)NTC}$  (see Figure 6 (4)) is reached.

## 8.8 Heat sink

In SSL21084T applications, the PCB copper acts as the heat sink. The IC has thermal leads (GND pins 2, 6, 10 and 11) for enhanced heat transfer from die to the PCB copper heat sink. The thermal lead connection can drastically reduce thermal resistance.

[Equation 1](#) shows the relationship between the maximum allowable power dissipation and the thermal resistance from junction to ambient.

$$R_{th(j-a)} = \frac{(T_{j(max)} - T_{amb})}{P} \quad (1)$$

Where:

$R_{th(j-a)}$  = thermal resistance from junction to ambient

$T_{j(max)}$  = maximum junction temperature

$T_{amb}$  = ambient temperature

P = Power dissipation

## 9. Limiting values

**Table 4. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Conditions	Min	Max	Unit
<b>General</b>					
SR	slew rate	on pin DRAIN	−5	+5	V/ns
P <sub>tot</sub>	total power dissipation	SO12 package	-	1	W
T <sub>amb</sub>	ambient temperature		−40	+125	°C
T <sub>j</sub>	junction temperature		−40	+150	°C
T <sub>stg</sub>	storage temperature		−55	+150	°C
<b>Voltages</b>					
V <sub>CC</sub>	supply voltage	continuous	[1] −0.4	+20	V
V <sub>DRAIN</sub>	voltage on pin DRAIN		−0.4	+600	
V <sub>HV</sub>	voltage on pin HV	current limited	−0.4	+600	V
V <sub>SOURCE</sub>	voltage on pin SOURCE	current limited	−0.4	+5.2	V
V <sub>NTC</sub>	voltage on pin NTC	current limited	−0.4	+5.2	V
V <sub>TONMOD</sub>	voltage on pin TONMOD	current limited	−0.4	+5.2	V
<b>Currents</b>					
I <sub>DD</sub>	supply current	on pin VCC	[2] -	20	mA
I <sub>DRAIN</sub>	current on pin DRAIN		−1	+1	A
I <sub>SOURCE</sub>	current on pin SOURCE		−1	+1	A
I <sub>DVTD</sub>	current on pin DVTD	duration 20 μs maximum	-	1.3	A
<b>Electrostatic discharge</b>					
V <sub>ESD</sub>	electrostatic discharge voltage	human body model; pins DRAIN and HV	−1	+1	kV
		human body model; all other pins	[3] −2	+2	kV
		charged device	[4] −500	+500	V

[1] The current flowing into the VCC pin must not exceed the maximum I<sub>DD</sub> value.

[2] An internal clamp sets the supply voltage.

[3] Human body model: equivalent to discharging a 100 pF capacitor through a 1.5 kΩ series resistor.

[4] Charged device model: equivalent to charging the IC up to 1 kV and the subsequent discharging of each pin down to 0 V over a 1 Ω resistor.

## 10. Thermal characteristics

**Table 5. Thermal characteristics**

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air; PCB: 2 cm × 3 cm; 2-layer; 35 $\mu$ m Cu per layer	121	K/W
		in free air; PCB: JEDEC 2s2p	53	K/W
$\Psi_{j-top}$	thermal characterization parameter from junction to top of package	top package temperature measured at the warmest point on top of the case	3.4	K/W

## 11. Characteristics

**Table 6. Characteristics**

Values specified at  $T_{amb} = 25^{\circ}\text{C}$  unless otherwise specified; all voltages are measured with respect to ground; currents are positive when flowing into the IC.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$f_{conv}$	conversion frequency		-	100	-	kHz
<b>High-voltage</b>						
$I_{leak(DRAIN)}$	leakage current on pin DRAIN	$V_{DRAIN} = 600\text{ V}$	-	-	10	$\mu\text{A}$
$I_{leak(HV)}$	leakage current on pin HV	$V_{HV} = 600\text{ V}$	-	-	30	$\mu\text{A}$
<b>Supply</b>						
$V_{CC}$	supply voltage	operating range	[1] 8	-	16	V
$V_{CC(startup)}$	start-up supply voltage		11	12	13	V
$V_{CC(stop)}$	stop supply voltage		8	9	10	V
$V_{CC(hys)}$	hysteresis of supply voltage	between $V_{CC(startup)}$ and $V_{CC(stop)}$	2	-	4.5	V
$V_{CC(rst)}$	reset supply voltage		4.5	5	5.5	V
$V_{CC(swon)reg}$	regulator switch-on supply voltage		8.75	9.25	9.75	V
$V_{CC(swoff)reg}$	regulator switch-off supply voltage		9.5	10	10.5	V
$V_{CC(reg)hys}$	regulator supply voltage hysteresis	$V_{CC(swoff)reg} - V_{CC(swon)reg}$	0.3	-	-	V
$V_{CC(regswon-stop)}$	supply voltage difference between regulator switch-on and stop	$V_{CC(swon)reg} - V_{CC(stop)}$	0.3	-	-	V
<b>Consumption</b>						
$I_{stb(HV)}$	standby current on pin HV	during start-up or in protection; $V_{HV} = 100\text{ V}$	300	350	400	$\mu\text{A}$
$I_{CC(INT)}$	internal supply current	normal operation	-	1.3	-	mA
<b>Capability</b>						
$I_{sup(high)HV}$	high supply current on pin HV	Standby: $V_{HV} = 40\text{ V}$ ; $V_{CC} < V_{CC(stop)}$	1	1.3	1.6	mA
		Regulator on: $V_{HV} = 40\text{ V}$ ; $V_{CC} < V_{CC(swon)reg}$ after start-up	2	2.3	2.6	mA

**Table 6. Characteristics ...continued**

Values specified at  $T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified; all voltages are measured with respect to ground; currents are positive when flowing into the IC.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Current and SWP</b>						
$V_{th(ocp)SOURCE}$	overcurrent protection threshold voltage on pin SOURCE	$\Delta V/\Delta t = 0.1\text{ V}/\mu\text{s}$	480	500	520	mV
		$\Delta V/\Delta t = 0.1\text{ V}/\mu\text{s}; V_{NTC} = 0.325\text{ V}$	230	250	270	mV
$t_{d(ocp-swoff)}$	delay time from overcurrent protection to switch-off	$\Delta V/\Delta t = 0.1\text{ V}/\mu\text{s}$	-	75	100	ns
$t_{leb}$	leading edge blanking time	overcurrent protection	260	300	340	ns
$\Delta t_{leb}$	leading edge blanking time difference	between $t_{leb}$ for OCP and SWP	30	50	-	ns
$V_{th(SWP)SOURCE}$	short-winding protection threshold voltage on pin SOURCE		1.4	1.5	1.6	V
<b>Valley detection</b>						
$(\Delta V/\Delta t)_{vrec}$	valley recognition voltage change with time	on pin DRAIN	-30	-20	-10	V/ $\mu\text{s}$
$f_{ring}$	ringing frequency		<a href="#">[2]</a> 200	550	1000	kHz
$\Delta V_{vrec(min)}$	minimum valley recognition voltage difference	voltage drop on pin DRAIN	15	20	25	V
$t_{d(vrec-swon)}$	valley recognition to switch-on delay time		-	100	-	ns
<b>Brownout detection</b>						
$V_{th(TONMOD)}$	threshold voltage on pin TONMOD		3.75	4	4.25	V
$I_{offset(TONMOD)}$	offset current on pin TONMOD		-37	-43	-48	$\mu\text{A}$
$t_{on(high)}$	high on-time		12.5	15	17.5	$\mu\text{s}$
<b>MOSFET output stage</b>						
$V_{BR(DRAIN)}$	breakdown voltage on pin DRAIN	$T_j > 0\text{ }^{\circ}\text{C}$	600	-	-	V
$R_{DSon}$	drain-source on-state resistance	$T_j = 25\text{ }^{\circ}\text{C}$	4	5	6	$\Omega$
		$T_j = 125\text{ }^{\circ}\text{C}$	6	7.5	9	$\Omega$
$(dV/dt)_f(DRAIN)$	fall rate of change of voltage on pin DRAIN	$C_{DRAIN} = 75\text{ pF}, R_{SOURCE} = 2.2\text{ }\Omega$ <a href="#">[2]</a>	-	1.5	-	V/ns
<b>NTC functionality</b>						
$V_{th(high)NTC}$	high threshold voltage on pin NTC		0.47	0.5	0.53	V
$V_{th(low)NTC}$	low threshold voltage on pin NTC		0.325	0.35	0.375	V
$V_{act(tmr)NTC}$	timer activation voltage on pin NTC		0.26	0.3	0.325	V
$V_{deact(tmr)NTC}$	timer deactivation voltage on pin NTC		0.17	0.2	0.23	V
$t_{to(deact)NTC}$	deactivation time-out time on pin NTC		33	46	59	$\mu\text{s}$
$I_{offset(NTC)}$	offset current on pin NTC		-	-47	-	$\mu\text{A}$

**Table 6. Characteristics** ...continued

Values specified at  $T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified; all voltages are measured with respect to ground; currents are positive when flowing into the IC.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Temperature protection</b>						
$T_{th(act)otp}$	overtemperature protection activation threshold temperature		160	170	180	$^{\circ}\text{C}$
$T_{th(rel)otp}$	overtemperature protection release threshold temperature		90	100	110	$^{\circ}\text{C}$

[1] An internal clamp sets the supply voltage. The current into the VCC pin must not exceed the maximum  $I_{DD}$  value (see [Table 4](#)).

[2] This parameter is not tested during production, by design it is guaranteed



12. Package outline

SO12: plastic small outline package; 12 leads; body width 3.9 mm

SOT1196-1

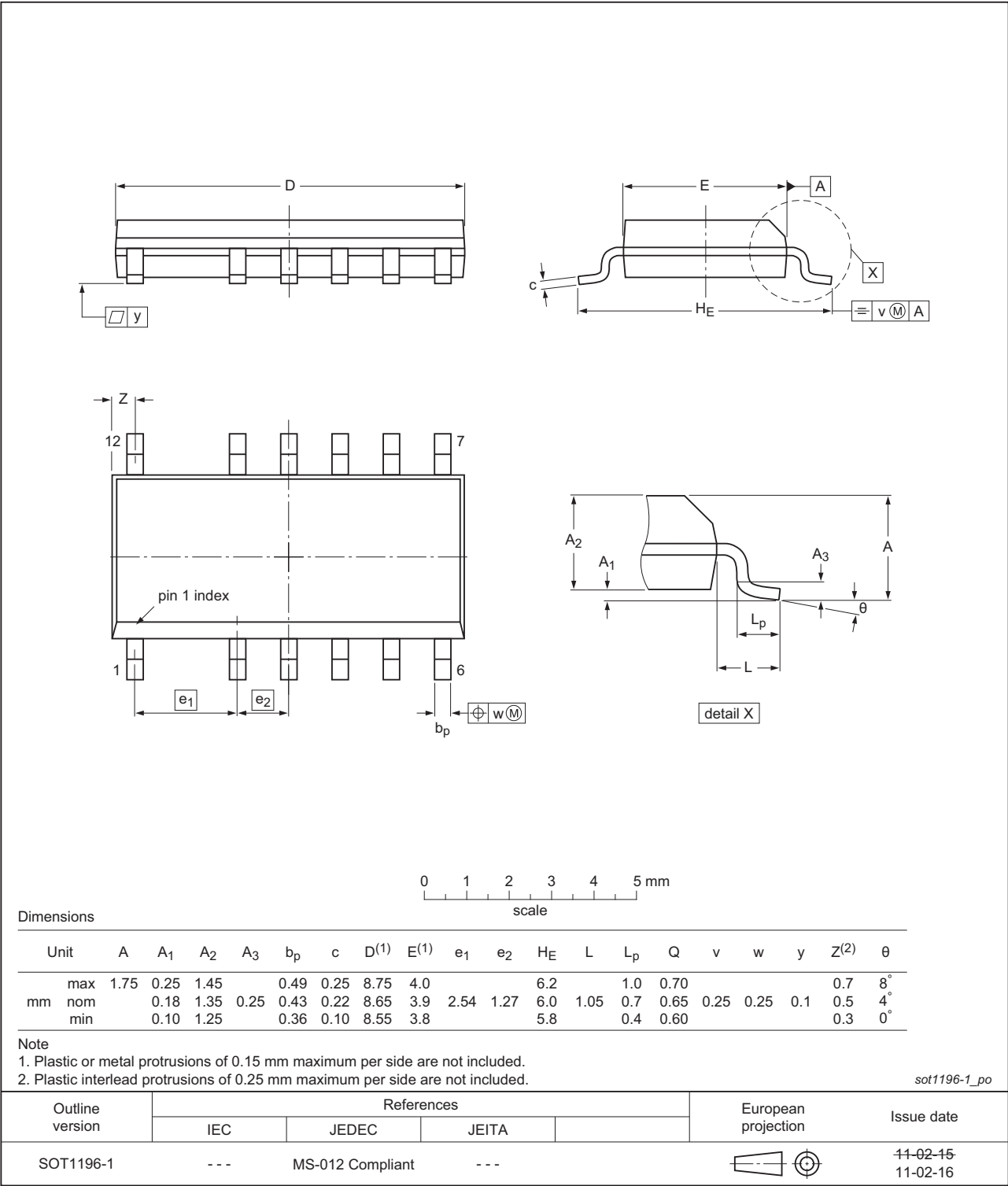


Fig 7. Package outline SOT1196-1 (SO12)